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following ratings, tested by independent agencies:. a) A Glow Wire Ignition Temperature (GWIT) of at least 775 deg C per IEC 60695-2-13 b) A Glow Wire Flammability Index (GWFI) above 850 deg C per IEC 60695-2-12.and hence complies with the requirements set out in the International Standard IEC 60335-1 5th edition - household and similar electrical appliances - safety, section 30 Resistance to heat and fire. <p><p> The customers using this product must determine its suitability for use in their particular application through testing or other acceptable means as described in end-product glow-wire flammability test</p></p>		0430451013 Active Micro-Fit Connector System Micro-Fit 3.0 Vertical Header, Polarizing Peg, Gold, Glow-W	3.00mm Pitch, Dual Row, 10 Circuits, with PCB /ire Capable, Black <u>Test Summary TS-43045-002-001 (PDF)</u> <u>Test Summary TS-46235-001-001 (PDF)</u> <u>RoHS Certificate of Compliance (PDF)</u> <u>Product Literature (PDF)</u>	Series image - Reference only
standard IEC 60695-2-11 and any applicable product end-use standard(s). <p> If it is determined during the customer's evaluation of suitability, that higher performance is required, please contact Molex for possible product options."""""""""High Temperature  Square Pin Offset Through Hole Mounting Solder Type<p><p>This Molex product is manufactured from material that has the following ratings, tested by independent agencies:. a) A Glow Wire Ignition Temperature (GWIT) of at least 775 deg C per IEC 606095-2-13. b) A Glow Wire Flammability Index (GWFI) above 850 deg C per IEC 60695-2-12.and hence complies with the requirements set out in the International Standard IEC 60335-1 5th edition - household and similar electrical appliances - safety,</p></p></p>	CSA UL General Product Family Series 3D Viewer Application CURRENT-MAX-N		E29179 PCB Headers <u>43045</u> Yes Power, Wire-to-Board 8.5 """"""""High Temperature Square Pin Offset Through Hole Mounting Solder Type <p><p>This Molex product is manufactured from material that has the following ratings, tested by independent agencies:. a) A Glow Wire Ignition Temperature (GWIT) of at least 775 deg C per IEC 60695-2-13 b) A Glow Wire Flammability Index (GWFI) above 850 deg C per IEC 60695-2-12.and hence comples with the requirements set out in the International Standard IEC 60335-1 5th edition - household and similar electrical appliances - safety, section 30 Resistance to heat and fire. <p><p> The customers using this product must determine its suitability for use in their particular application through testing or other acceptable means as described in end-product glow-wire flammability test standard IEC 60695-2-11 and any applicable product end-use standard(s). <p> If it is determined during the customer's evaluation of suitability, that higher performance is required, please contact Molex for possible product options."""""""High Temperature  Square Pin Offset Through Hole Mounting Solder Type<p><p>This Molex product is manufactured from material that has the following ratings, tested by independent agencies:. a) A Glow Wire Ignition Temperature (GWIT) of at least 775 deg C per IEC 60695-2-13 b) A Glow Wire Flammability Index (GWFI) above 850 deg C per IEC 60695-2-12.and hence complies with the requirements set out in the International Standard IEC 60335-1 5th edition -</p></p></p></p></p></p></p>	Not RelevantEU RoHSChina RoHSCompliantChina RoHSREACH SVHCNot Contained PerNot Contained Per-ED/88/2018 (15January 2019)Halogen-FreeStatusLow-HalogenFor more information, please visit Contact USChina ROHSGreen ImageELVNot RelevantRoHS PhthalatesNot ContainedSearch Parts in this Series43045 SeriesMates WithMicro-Fit 3.0 Receptacle Housing 43025    Micro-Fit 3.0 TPA Receptacle Housing

Overview PITCH-MATING-NUMERIC Product Literature Order No Product Name UPC	IEC 60695-2-11 and any applicable product end- use standard(s). <p> If it is determined during the customer's evaluation of suitability, that higher performance is required, please contact Molex for possible product options.""""""" <u>Micro-Fit Connector System</u> 3.00 987650-5984 Micro-Fit 3.0 800753746480</p>
Dhysical	
Physical Breakaway	No
Circuits (Loaded)	10
Circuits (maximum)	10
Color - Resin	Black
Durability (mating cycles max)	30
Flammability	94V-0
Glow-Wire Capable	Yes
Mated Height	17.64mm
Material - Metal Material - Plating Mating	Brass Gold
Material - Plating Mating Material - Plating Termination	Tin
Material - Resin	High Temperature Thermoplastic
Net Weight	1.448/g
Number of Rows	2
Orientation	Vertical
PCB Locator	Yes
PCB Retention	Yes
PCB Thickness - Recommended	1.60mm
Packaging Type Pitch - Mating Interface	Tray 3.00mm
Plating min - Mating	0.381µm
Polarized to PCB	Yes
Shrouded	Fully
Stackable	No
Surface Mount Compatible (SMC)	Yes
Temperature Range - Operating	-40° to +105°C
Termination Interface: Style	Through Hole - Kinked Pin
Electrical	
Current - Maximum per Contact	8.5A
Voltage - Maximum	600V
Solder Process Data	
Duration at Max. Process Temperature (seconds)	030
Lead-freeProcess Capability	SMC&WAVE
Max. Cycles at Max. Process Temperature	003
Process Temperature max. C	260
Material Info	
Reference - Drawing Numbers	
Packaging Specification	PK-70873-0314-001
Sales Drawing	SD-43045-005
Symbol/Footprint Data	SYM-43045-1012, SYM-43045-101X
Test Summary	TS-43045-001-001, TS-43045-002-001, TS-46235-001-001

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